

# **MOS FIELD EFFECT TRANSISTOR** 2SK4069

## **SWITCHING N-CHANNEL POWER MOSFET**

#### DESCRIPTION

The 2SK4069 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

#### **FEATURES**

- Low on-state resistance
- $R_{DS(on)1} = 12 \text{ m}\Omega \text{ MAX.}$  (Vgs = 10 V, ID = 15 A)
- Low QGD: QGD = 3.2 nC TYP.
- 4.5 V drive available

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ )

Drain to Source Voltage (V <sub>GS</sub> = 0 V)	VDSS	25	V
Gate to Source Voltage (VDs = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±30	А
Drain Current (pulse) Note1	D(pulse)	±120	А
Total Power Dissipation (Tc = $25^{\circ}$ C)	<b>P</b> T1	21	W
Total Power Dissipation	Рт2	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note2	las	18	А
Single Avalanche Energy Note2	Eas	32.4	mJ

## PART NI IMBER

**ORDERING INFORMATION** 

PART NUMBER	PACKAGE	
2SK4069-S15-AY Note	TO-251(MP-3-b)	
2SK4069-ZK-E1-AY <sup>Note</sup>	TO-252 (MP-3ZK)	
2SK4069-ZK-E2-AY Note	TO-252 (MP-3ZK)	

Note Pb-free (This product does not contain Pb inexternal

electrode.)

(TO-251)



(TO-252)



**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

**2.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 12 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V, L = 100  $\mu$  H

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The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

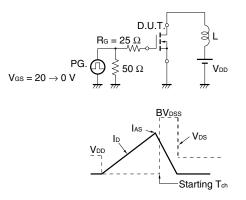
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### ELECTRICAL CHARACTERISTICS (TA = 25°C)

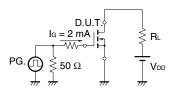
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V			10	μA
Gate Leakage Current	lgss	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V			±100	nA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance Note	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 7.5 A	5	10		S
Drain to Source On-state Resistance Note	RDS(on)1	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		9.4	12	mΩ
	RDS(on)2	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		15	21	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		860		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		255		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		90		pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = 12 V, I <sub>D</sub> = 30 A		14/7.5		Ns
Rise Time	tr	V <sub>GS</sub> = 4.5 V/12 V		13/4.2		Ns
Turn-off Delay Time	$t_{d(off)}$	R <sub>G</sub> = 3 Ω		1.9/24		Ns
Fall Time	tr			14/4.4		Ns
Total Gate Charge	Q <sub>G1</sub>	V <sub>DD</sub> = 12 V ,V <sub>GS</sub> = 12 V, I <sub>D</sub> = 30 A		17		nC
Total Gate Charge	Q <sub>G2</sub>	V <sub>DD</sub> = 12 V ,V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 30 A		6.7		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>DD</sub> = 12 V , I <sub>D</sub> = 30 A		2.4		nC
Gate to Drain Charge	Qgd			3.2		nC
Gate Resistance	Rg			1.5		Ω
Body Diode Forward Voltage Note	VF(S-D)	IF = 30 A, V <sub>GS</sub> = 0 V		0.9	1.5	V
Reverse Recovery Time	trr	IF = 30 A, V <sub>GS</sub> = 0 V		29		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>μ</i> s		20		nC

Note Pulsed

#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

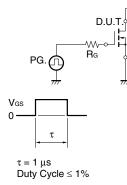


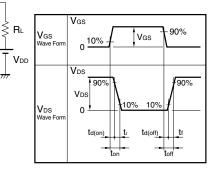
#### **TEST CIRCUIT 3 GATE CHARGE**



#### **TEST CIRCUIT 2 SWITCHING TIME**

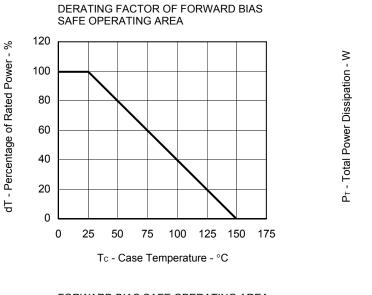
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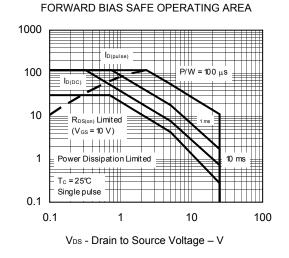


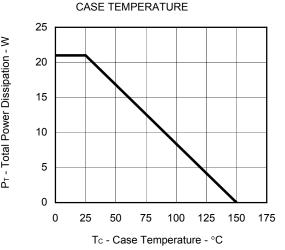


Ip - Drain Current - A

### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

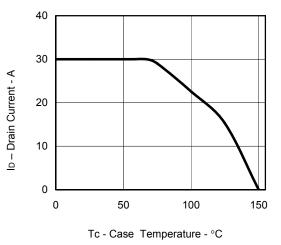




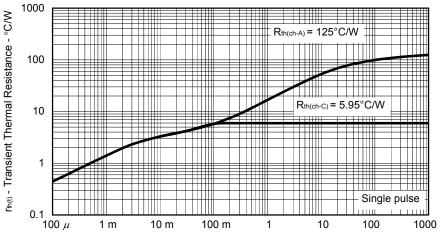


TOTAL POWER DISSIPATION vs.

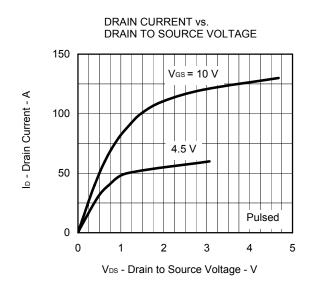
DRAIN CURRENT vs CASE TEMPERATURE



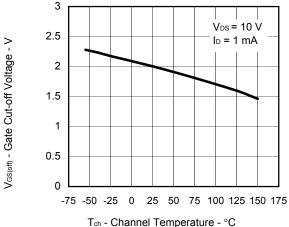
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



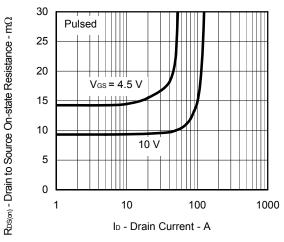
PW - Pulse Width - s



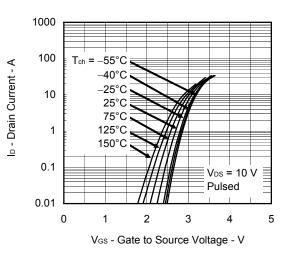




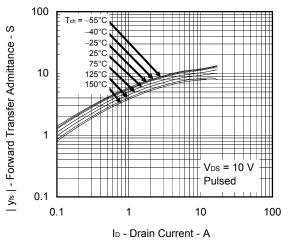
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



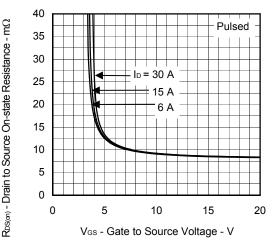
FORWARD TRANSFER CHARACTERISTICS



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



0.01

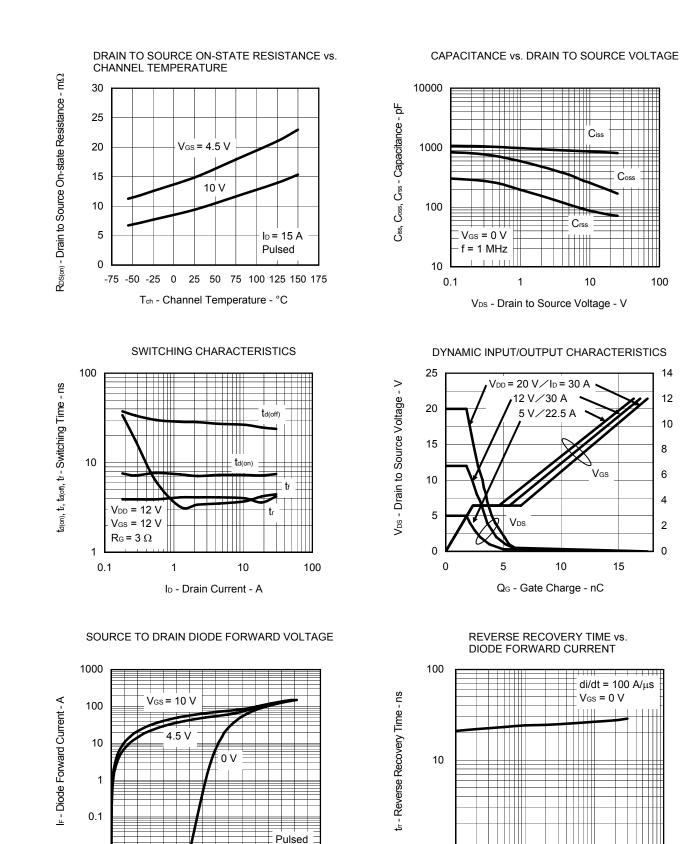
0

0.5

VF(S-D) - Source to Drain Voltage - V

1

1.5



1

IF - Diode Forward Current - A

10

1

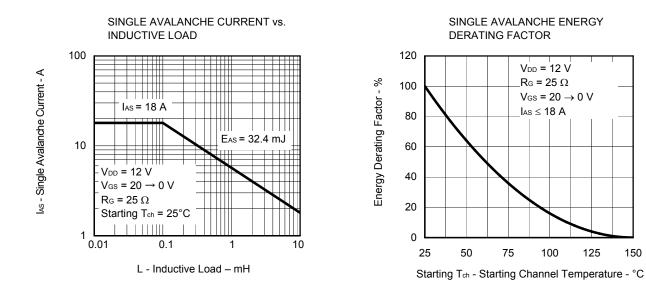
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#### Data Sheet D18032EJ2V0DS

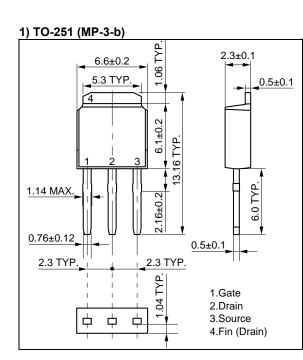
100

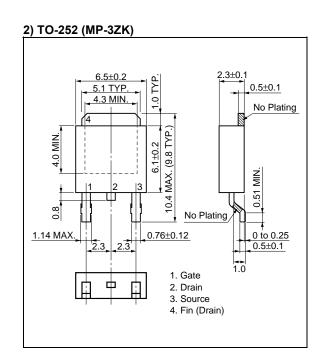
V<sub>GS</sub> - Gate to Source Voltage - V

150

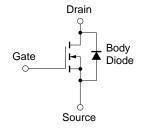


### PACKAGE DRAWINGS (Unit: mm)





#### **EQUIVALENT CIRCUIT**



**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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